

# 2A, 50V - 1000V Surface Mount Rectifiers

## FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop

**MECHANICAL DATA** 

- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition







DO-214AC (SMA)

# Case: DO-214AC (SMA) Molding compound, UL flammability classification rating 94V-0 Moisture sensitivity level: level 1, per J-STD-020 Part no. with suffix "H" means AEC-Q101 qualified Packing code with suffix "G" means green compound (halogen-free) Terminal: Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 2 whisker test Polarity: Indicated by cathode band Weight: 0.06 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)									
PARAMETER	SYMBOL	S2	S2	S2	S2	S2	S2	S2	UNIT
		AA	BA	DA	GA	JA	KA	MA	_
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>		-		1.5	-	-	-	А
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>				50				A
Maximum instantaneous forward voltage (Note 1) @ 1.5 A	V <sub>F</sub>				1.1				V
Maximum reverse current @ rated $V_R$ T <sub>J</sub> =25°C T <sub>J</sub> =125°C	I <sub>R</sub>	5 125			μA				
Typical reverse recovery time (Note 2)	t <sub>rr</sub>				1.5				μs
Typical junction capacitance (Note 3)	CJ				30				pF
Typical thermal resistance	$R_{ extsf{ heta}JL}$ $R_{ extsf{ heta}JA}$	16 53					°C/W		
Operating junction temperature range	TJ	- 55 to +150					°C		
Storage temperature range	T <sub>STG</sub>	- 55 to +150					°C		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.



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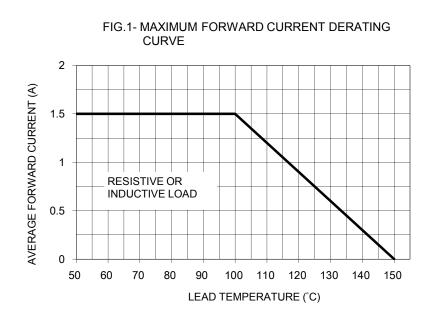
### ORDERING INFORMATION

PART	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
NO.	SUFFIX		SUFFIX		
		R3	R2 M2 F3	SMA	1,800 / 7" Plastic reel
		R2		SMA	7,500 / 13" Paper reel
S2xA	ц	M2		SMA	7,500 / 13" Plastic reel
(Note 1)	Н	F3		Folded SMA	1,800 / 7" Plastic reel
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

Note 1: "x" defines voltage from 50V (S2AA) to 1000V (S2MA)

EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
S2MAHR3G	S2MA	Н	R3	G	AEC-Q101 qualified Green compound

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub>=25°C unless otherwise noted)



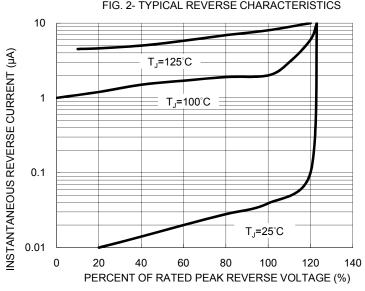
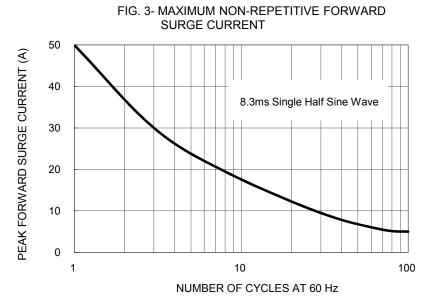
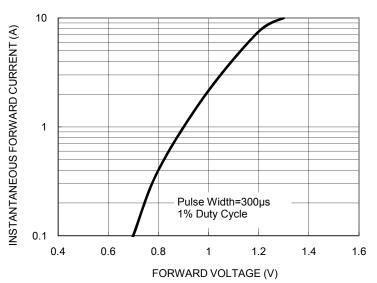


FIG. 2- TYPICAL REVERSE CHARACTERISTICS



### FIG. 4 TYPICAL FORWARD CHARACTERISTICS





# S2AA - S2MA

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### FIG. 5 TYPICAL JUNCTION CAPACITANCE

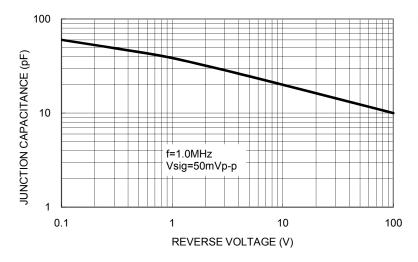
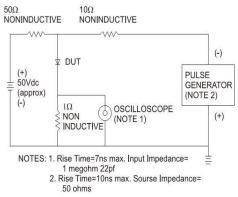
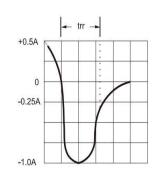
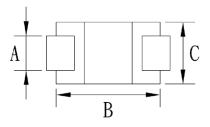


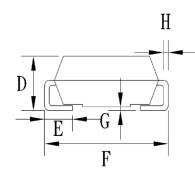
FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





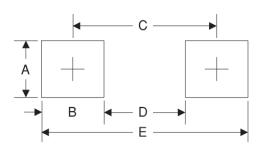
# PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)





DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min	Max	Min	Max	
А	1.27	1.58	0.050	0.062	
В	4.06	4.60	0.160	0.181	
С	2.29	2.83	0.090	0.111	
D	1.99	2.50	0.078	0.098	
E	0.90	1.41	0.035	0.056	
F	4.95	5.33	0.195	0.210	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

# SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

# MARKING DIAGRAM



- P/N = Specific Device Code
- G = Green Compound
- YW = Date Code
- F = Factory Code



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